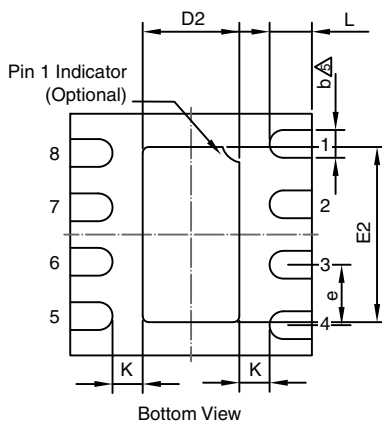
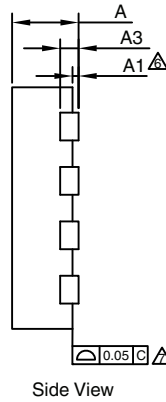
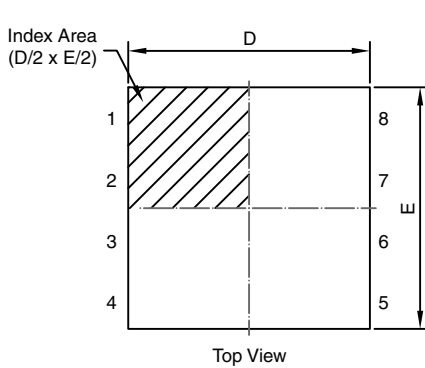


CASE OUTLINE FOR TDFN8 2 x 2



DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.50	0.55	0.60	0.020	0.022	0.024
A1	0.00	-	0.05	0.000	-	0.002
A3	0.152 REF			0.006 REF		
b	0.18	0.23	0.28	0.007	0.009	0.011
D	1.95	2.00	2.05	0.077	0.079	0.081
D2	0.75	0.80	0.85	0.030	0.031	0.033
e	0.50 BSC			0.020 BSC		
E	1.95	2.00	2.05	0.077	0.079	0.081
E2	1.40	1.45	1.50	0.055	0.057	0.059
K	-	0.20	-	-	0.008	-
L	0.30	0.35	0.40	0.012	0.014	0.016

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Note

- All dimensions are in millimeters which will govern.
 - Max. package warpage is 0.05 mm.
 - Max. allowable burrs is 0.076 mm in all directions.
 - Pin #1 ID on top will be laser/ink marked.
- ⁵ Dimension applies to metallized terminal and is measured between 0.20 mm and 0.25 mm from terminal tip.
⁶ Applied only for terminals.
⁷ Applied for exposed pad and terminals.